

## Particle movement in shear cavity flow for different Stokes number using lattice Boltzmann method

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### **ABSTRACT**

In this paper, lattice Boltzmann scheme is used to simulate particle flow in a steady incompressible flow inside a square cavity. Numerical simulations are carried out for Reynolds number of 130, 400 and 860. Comparisons for three different Stokes number of Stokes number,  $St = 0.06$ ,  $St = 0.21$ ,  $St = 0.41$  are carried out under Reynolds Number 400. The governing equation use is the double-population lattice Boltzmann formulation. Two-dimensional nine velocity model is used for the computation of velocity field. The results obtained by using compact visual FORTRAN are compared with the results found in the literature review. Present study found that lattice Boltzmann scheme is able to carry out equivalent results as conventional scheme.

### **KEYWORDS:**

lattice Boltzmann scheme; Lid-driven square cavity

## REFERENCES

1. Ghia, U., Ghia, K.N., Shin, C.T. High-Re solutions for incompressible flow using the Navier-Stokes equations and a multigrid method. (1982) *Journal of Computational Physics*, 48 (3), pp. 387-411.
2. Erturk, E., Corke, T.C., Gökçöl, C. Numerical solutions of 2-D steady incompressible driven cavity flow at high Reynolds numbers. (2005) *International Journal for Numerical Methods in Fluids*, 48 (7), pp. 747-774.
3. Albensoeder, S., Kuhlmann, H.C. Accurate three-dimensional lid-driven cavity flow. (2005) *Journal of Computational Physics*, 206 (2), pp. 536-558
4. Filippova, O., Hänel, D. Grid Refinement for Lattice-BGK Models. (1998) *Journal of Computational Physics*, 147 (1), pp. 219-228.
5. Cheng, M., Hung, K.C. Vortex structure of steady flow in a rectangular cavity. (2006) *Computers and Fluids*, 35 (10), pp. 1046-1062.